TFT DISPLAY SPECIFICATION

WINSTAR Display Co.,Ltd.

華凌光電股份有限公司

Winstar Display Co., LTD
華凌光電股份有限公司
WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER : _____

MODULE NO.: WF57STIACDNT0#

APPROVED BY: **(FOR CUSTOMER USE ONLY)**	**PCB VERSION:** **DATA:**

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
			葉虹蘭
ISSUED DATE: 2017/08/22			

TFT Display Inspection Specification: https://www.winstar.com.tw/technology/download.html

MODLE NO：

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	**SUMMARY**
0	2014/03/26		First issue
A	2014/07/24		Modify Package Specification.
B	2015/03/16		Add size,Surface &Resistance Touch Panel General Specification.. Modify Pixel Data Format & Block Diagram Remove the description of TFT color part
C	2015/04/27		Modify Reliability.
D	2015/11/02		Modify Initial Code.
E	2016/01/12		Modify touchpanel.
F	2016/01/21		Modify Static electricity test
G	2016/08/10		Modify Vibration test.
H	2016/10/05		Modify Summary Add Aspect Ratio
I	2017/08/22		Remove Package Specification

Contents

1.Module Classification Information

W	F	57	S	T	I	A	C	D	N	T	0	#
①	②	③	④	⑤	⑥	⑦	⑧	⑨	⑩	⑪	⑫	⑬

①	Brand：WINSTAR DISPLAY CORPORATION		
②	Display Type：F→TFT Type, J→Custom TFT		
③	Display Size：5.7” TFT		
④	Model serials no.		
⑤	Backlight Type：	F→CCFL, White S→LED, High Light White	T→LED, White Z→Nichia LED, White
⑥	LCD Polarize Type/ Temperature range/ Gray Scale Inversion Direction	A→Transmissive, N.T, IPS TFT C→Transmissive, N. T, 6:00 ; F→Transmissive, N.T,12:00 ; I→Transmissive, W. T, 6:00 K→Transflective, W.T,12:00 L→Transmissive, W.T,12:00 N→Transmissive, Super W.T, 6:00	Q→Transmissive, Super W.T, 12:00 R→Transmissive, Super W.T, O-TFT V→Transmissive, Super W.T, VA TFT W→Transmissive, Super W.T, IPS TFT X→Transmissive, W.T, VA TFT Y→Transmissive, W.T, IPS TFT Z→Transmissive, W.T, O-TFT
⑦	A：TFT LCD B：TFT+SCREW HOLES+CONTROL BOARD C：TFT+ SCREW HOLES +A/D BOARD D：TFT+ SCREW HOLES +A/D BOARD+CONTROL BOARD E：TFT+ SCREW HOLES +POWER BOARD		F：TFT+CONTROL BOARD G：TFT+ SCREW HOLES H：TFT+D/V BOARD I：TFT+ SCREW HOLES +D/V BOARD J：TFT+POWER BD

⑧ Resolution:

A	128160	B	320234	C	320240	D	480234	E	480272	F	640480
G	800480	H	1024600	I	320480	J	240320	K	800600	L	240400
M	1024768	N	128128	P	1280800	Q	480800	R	640320	S	480128
T	800320	U	8001280	**V**	176220	W	1280398	X	1024250	Y	1920720
Z	800200	2	1024324	3	7201280	4	19201200	5	1366768	6	1280320

⑨ D: Digital L：LVDS M:MIPI

⑩ Interface:

N	Without control board	A	8Bit	B	16Bit	H	HDMI
I	I2C Interface	R	RS232	S	SPI Interface	U	USB

⑪ TS:

N	Without TS	T	Resistive touch panel	C	Capacitive touch panel (G-F-F)
G	Capacitive touch panel (G-G)	C1	Capacitive touch panel (G-F-F)+OCA		
C2	Capacitive touch panel (G-F-F)+OCR	G1	Capacitive touch panel (G-G)+OCA		
G2	Capacitive touch panel (G-G)+OCR	B	CTP+GG+USB		

⑫	Version: X:Raspberry pi	
⑬	Special Code	#:Fit in with ROHS directive regulations

2.Summary

The 5.7 " TN Mono TFT that is offers improved contrast ,viewing angle, brightness and response time over traditional passive monochrome products. Increased display brightness display brightness is a key factor for design engineers when selecting a display that must vividly show pictures and alphanumeric data.The TFT cell is manufactured using high aperture panel technology and high transmission polarizer. The result is a clear and extremely bright display.

3.General Specifications

Item	Dimension	Unit
Size	5.7	inch
Dot Matrix	320 x 240	dots
Module dimension	160.0 x 109.0 x 8.5	mm
Active area	115.2 x 86.4	mm
Dot pitch	0.36 x 0.36	mm
LCD type	TFT, Positive, Transmissive	
View Direction	12 o'clock	
Gray Scale Inversion Direction	6 o'clock	
Aspect Ratio	4:3	
Gray Scale	16 Gray scale (4BPP)/ 4 Gray scale (2BPP)/ 2 Gray scale (1BPP)	
Driver IC	ST7511U	
Backlight Type	LED, Normally White	
With /Without TP	With RTP	
Surface	Anti-Glare	

* Mono tone slight changed by temperature and driving voltage.

4.Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	TOP	-20	—	+70	℃
Storage Temperature	TST	-30	—	+80	℃

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp. ≦60℃, 90% RH MAX. Temp.＞60℃, Absolute humidity shall be less than 90% RH at 60℃

5.Electrical Characteristics

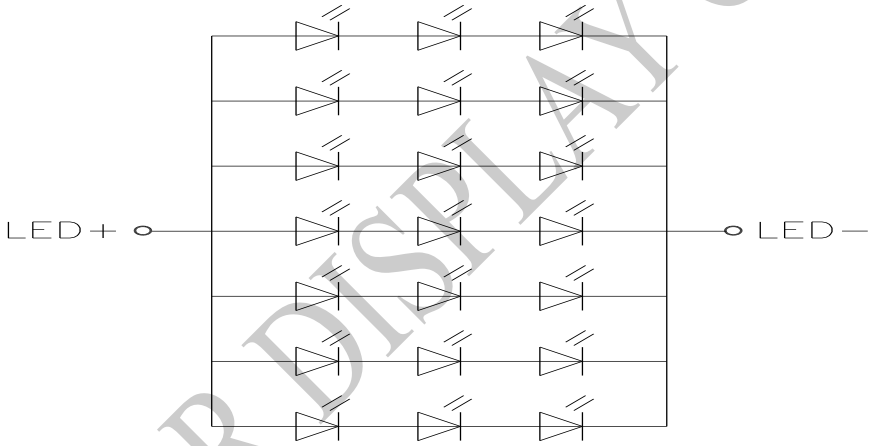
5.1. Operating conditions:

Item	Symbol	Condition	Min	Typ	Max	Unit	Remark
Supply Voltage For LCM	VDD	—	3.0	3.3	3.6	V	
Supply Current For LCM	IDD	—	—	20	30	mA	Note1
Power Consumption	—	—	—	66	108	mW	

Note1: This value is test for VDD=3.3V only

5.2. LED driving conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED current		-	140	-	mA	
Power Consumption		1120	-	1386	mW	
LED voltage	VLED+	8.0	9.0	9.9	V	Note 1
LED Life Time		-	50,000	-	Hr	Note 2,3,4



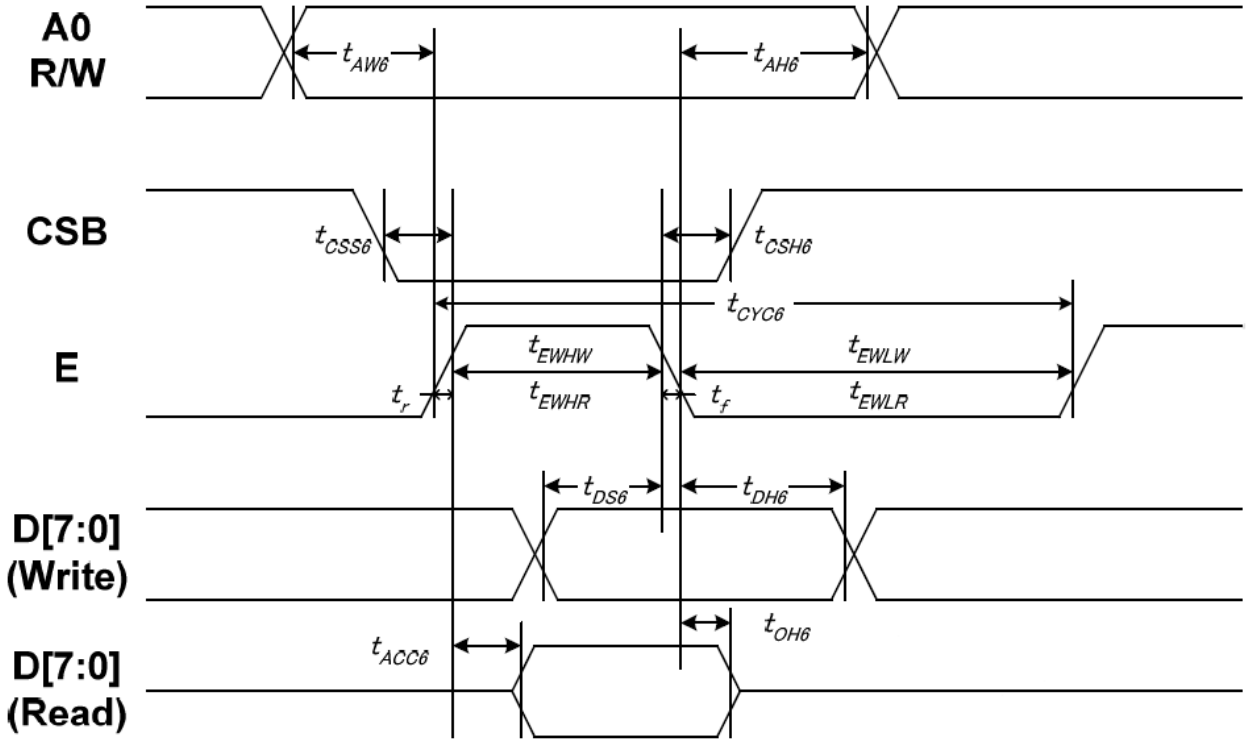
Note 1 : Power supply the back light specification
Note 2 : Ta = 25 ℃
Note 3 : Brightness to be decreased to 50% of the initial value
Note 4 : The single LED lamp case

6.DC CHARATERISTICS

Parameter	Symbol	Rating			Unit	Condition
		Min	Typ	Max		
Low level input voltage	V_{IL}	0	-	0.3VDD	V	
High level input voltage	V_{IH}	0.7VDD	-	VDD	V	

7.AC Characteristics

7.1. System Bus Timing for 6800 Series MPU

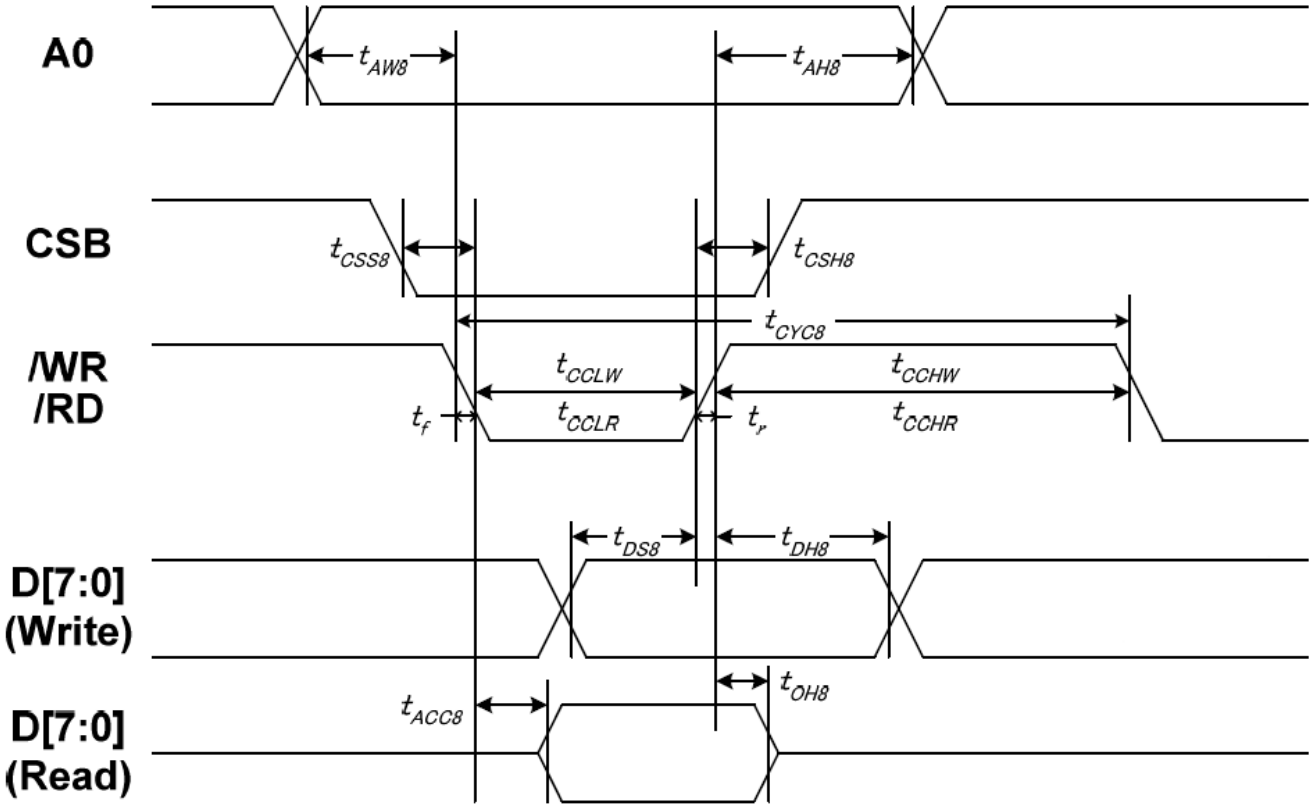


Item	Signal	Symbol	Condition	Min	Max	Unit
Address setup time	A0	tAW6	-	10	-	ns
Address hold time		tAH6	-	0	-	
System cycle time	E	tCYC6	-	200	-	
Enable L pulse width (WRITE)		tEWLW	-	100	-	
Enable H pulse width (WRITE)		tEWHW	-	100	-	
Enable L pulse width (READ)		tEWLR	-	130	-	
Enable H pulse width (READ)		tEWHR	-	130	-	
CSB setup time	CSB	tCSS6	-	100	-	
CSB hold time		tCSH6	-	100	-	
Write data setup time	D[7:0]	tDS6	-	70	-	
Write data hold time		tDH6	-	20	-	
Read data access time		tACC6	CL = 100 pF	-	80	
Read data output disable time		tOH6	CL = 100 pF	15	80	

Note:

1. The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time is extremely fast,(tr + tf) ≤ (tCYC8 – tCCLW – tCCHW) for (tr + tf) ≤ (tCYC8 – tCCLR – tCCHR) are specified.
2. All timing is specified using 20% and 80% of VDDI as the reference.
3. tCCLW and tCCLR are specified as the overlap between CSB being “L” and /WR and /RD being at the “L” level.CSB and /WR (or /RD) cannot act at the same time and CSB should be 100ns wider than /WR (or /RD).

7.2. System Bus Timing for 8080 Series MPU

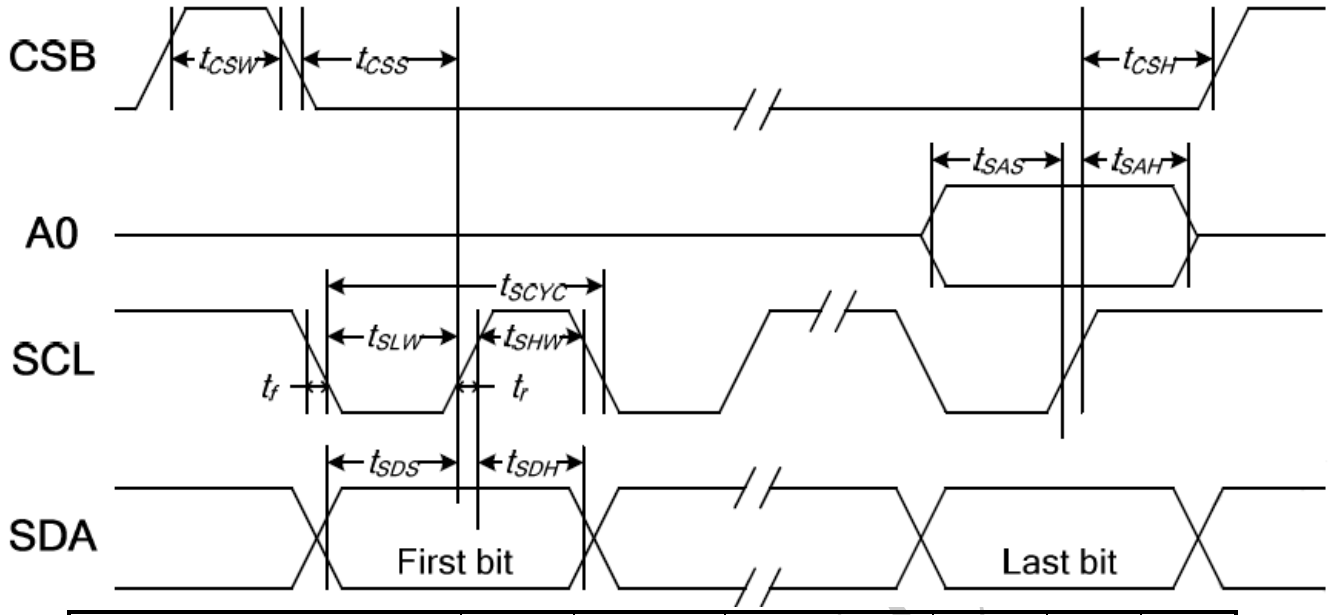


Item	Signal	Symbol	Condition	Min	Max	Unit
Address setup time	A0	tAW8	-	10	-	ns
Address hold time		tAH8	-	0	-	
System cycle time	/WR	tCYC8	-	200	-	
/WR L pulse width (WRITE)		tCCLW	-	100	-	
/WR H pulse width (WRITE)		tCCHW	-	100	-	
/RD L pulse width (READ)	/RD	tCCLR	-	120	-	
/RD H pulse width (READ)		tCCHR	-	120	-	
CSB setup time	CSB	tCSS8	-	100	-	
CSB hold time		tCSH8	-	100	-	
Write data setup time	D[7:0]	tDS8	-	70	-	
Write data hold time		tDH8	-	20	-	
Read data access time		tACC8	CL = 100 pF	-	80	
Read data output disable time		tOH8	CL = 100 pF	15	80	

Note:

1. The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time
   is extremely fast,(tr + tf) ≤ (tCYC8 – tCCLW – tCCHW) for (tr + tf) ≤ (tCYC8 – tCCLR – tCCHR) are
   specified.
2. All timing is specified using 20% and 80% of VDDI as the reference.
3. tCCLW and tCCLR are specified as the overlap between CSB being “L” and /WR and /RD being at the
   “L” level.CSB and /WR (or /RD) cannot act at the same time and CSB should be 100ns wider than /WR (or /RD).

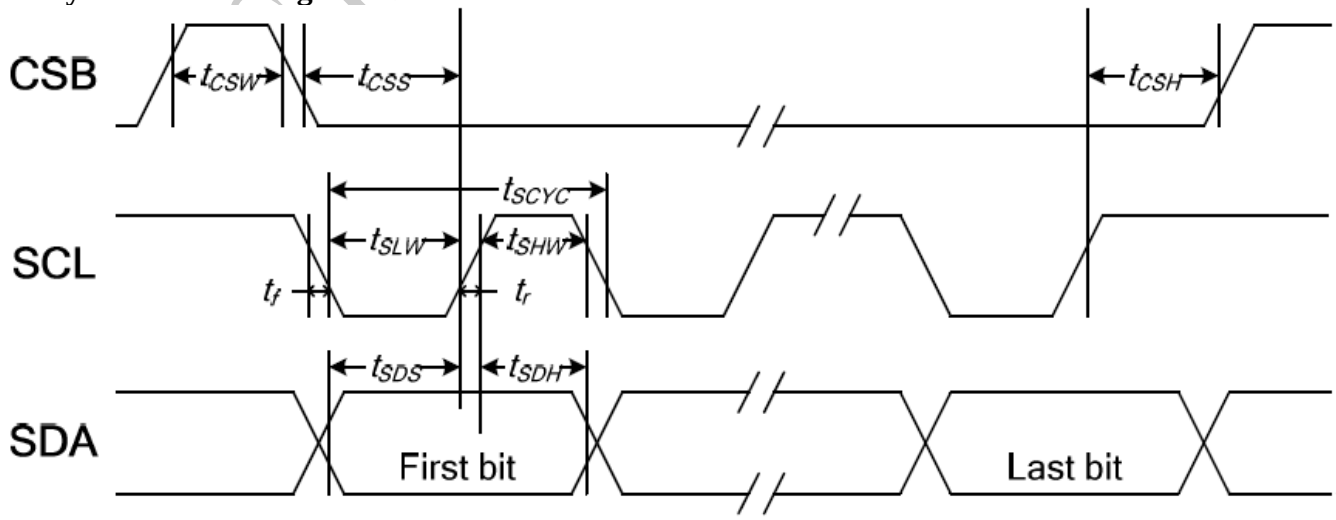
7.3. **System Bus Timing for 4-Line Serial Interface**



Item	Signal	Symbol	Condition	Min	Max	Unit
Serial clock period	SCL	tSCYC	-	80	-	ns
SCL “H” pulse width		tSHW	-	40	-	
SCL “L” pulse width		tSLW	-	40	-	
Address setup time	A0	tSAS	-	40	-	
Address hold time		tSAH	-	40	-	
Data setup time	SDA	tSDS	-	15	-	
Data hold time		tSDH	-	20	-	
CSB-SCL time	CSB	tCSS	-	40	-	
CSB-SCL time		tCSH	-	40	-	
CSB “H” pulse width		tCSW	-	15	-	

Note:
1. The input signal rise and fall time (tr, tf) are specified at 15 ns or less.
2. All timing is specified using 20% and 80% of VDDI as the standard.

7.4. System Bus Timing for 3-Line Serial Interface



Item	Signal	Symbol	Condition	Min	Max	Unit
Serial clock period	SCL	tSCYC	-	80	-	ns
SCL “H” pulse width		tSHW	-	40	-	
SCL “L” pulse width		tSLW	-	40	-	
Data setup time	SDA	tSDS	-	15	-	
Data hold time		tSDH	-	20	-	
CSB-SCL time	CSB	tCSS	-	40	-	
CSB-SCL time		tCSH	-	40	-	
CSB “H” pulse width		tCSW	-	15	-	

Note:

1. The input signal rise and fall time (tr, tf) are specified at 15 ns or less.
2. All timing is specified using 20% and 80% of VDDI as the standard.

8.Optical Characteristics

Item		Symbol	Condition.	Min	Typ.	Max.	Unit	Remark
Response time		Tr	θ =0°、Φ=0°	-	20	30	.ms	Note 3,5
		Tf		-	10	15	.ms	
Contrast ratio		CR	At optimized viewing angle	-	800	-	-	Note 4,5
Viewing angle	Hor.	ΘR	CR≧10	60			Deg.	Note 1
		ΘL		60				
	Ver.	ΦT		60				
		ΦB		50				
Brightness		-	-	630	700	-	cd/㎡	Center of display

Ta=25±2℃, IL=140mA

Note 1: Definition of viewing angle range

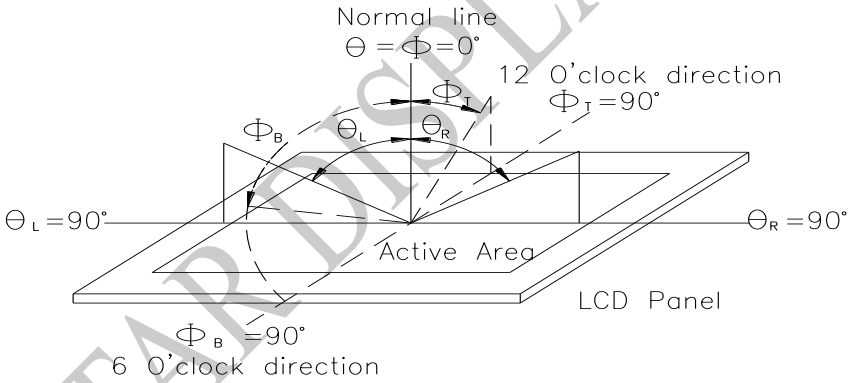


Fig.8.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7orBM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

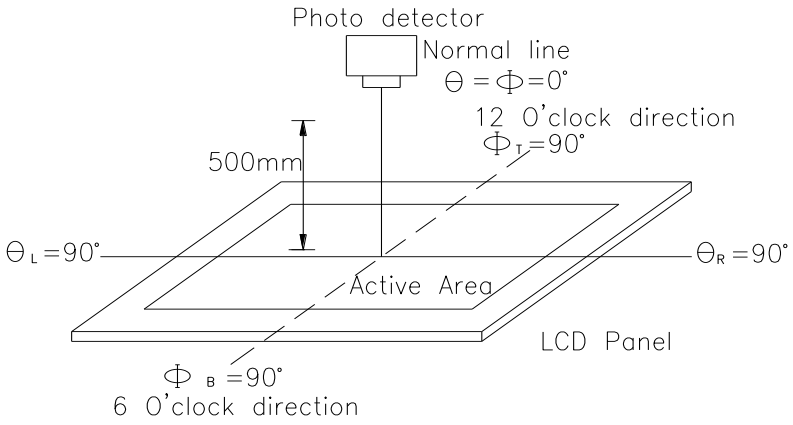
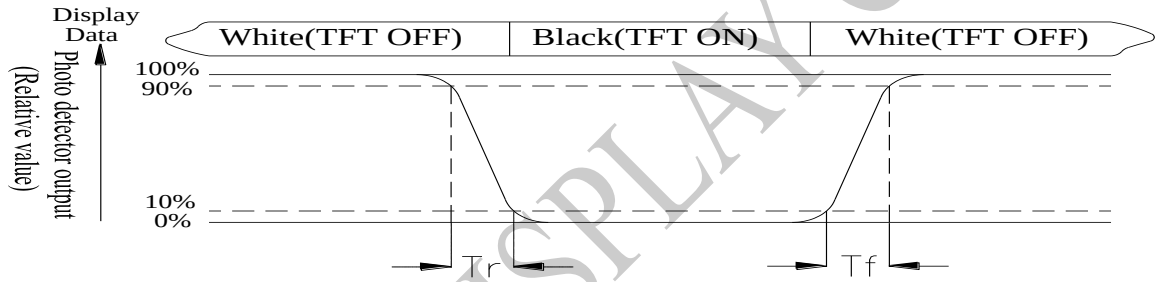


Fig. 8.2. Optical measurement system setup

Note 3: Definition of Response time:
The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, Tr, is the time between photo detector output intensity changed from 90%to 10%. And fall time, Tf, is the time between photo detector output intensity changed from 10%to 90%



Note 4: Definition of contrast ratio:
The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: White Vi = Vi50 ± 1.5V
Black Vi = Vi50 ± 2.0V
"±" means that the analog input signal swings in phase with VCOM signal.
"±" means that the analog input signal swings out of phase with VCOM signal.
The 100% transmission is defined as the transmission of LCD panel when all the input terminals of module are electrically opened.

Note 6: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

9.Interface

9.1. LCM PIN Definition

Pin	Symbol	Function	Remark
1	GND	System ground	
2	VDD	Power Supply : +3.3V	
3	NC	No connect	
4	A0	Data/Command select	
5	/WR(R/W)	Write strobe signal	
6	/RD(E)	Read strobe signal	
7	DB0	Data bus	
8	DB1	Data bus	
9	DB2	Data bus	
10	DB3	Data bus	
11	DB4	Data bus	
12	DB5	Data bus	
13	DB6	Data bus	
14	DB7	Data bus	
15	/CS	Chip select	
16	/RESET(RSTB)	Hardware reset	
17	IF0	Mode select	Note1
18	IF1		
19	NC	No connect	
20	NC	No connect	
21	NC	No connect	
22	NC	No connect	

Note1:

Setting		MCU Type	Interface Pin Function				
IF1	IF0		CSB	A0	RWR	ERD	D[7:0]
L	L	Parallel 8080 series MCU	CSB	A0	/WR	/RD	D[7:0]
L	H	Parallel 6800 series MCU			R/W	E	
H	H	Serial 4-Line series MCU			-	-	D7=SCL, D0=SDA, D[6:1] are not used
H	L	Serial 3-Line series MCU		-	-	-	

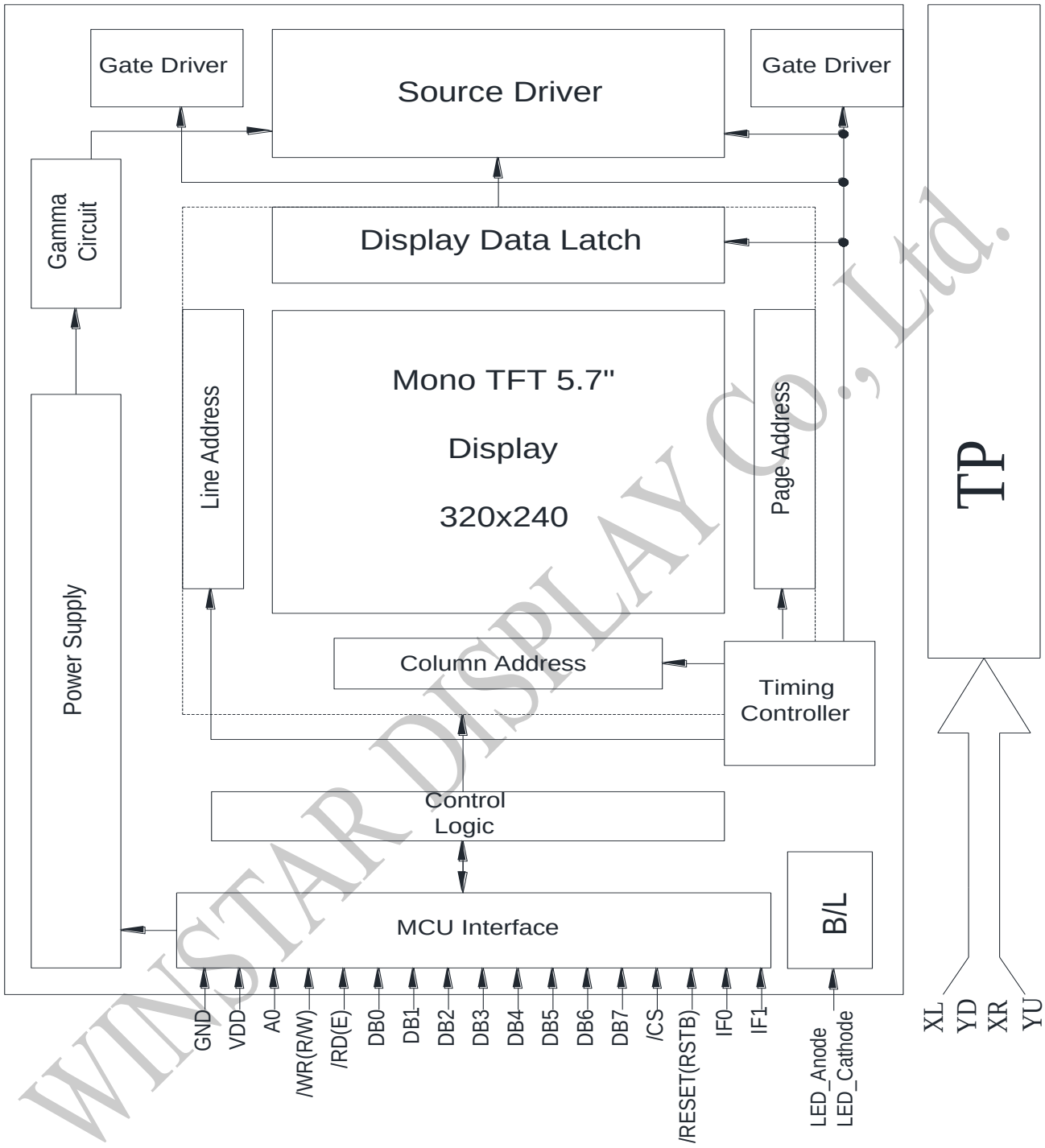
The un-used pins are marked as "-" and should be connected to "H" by VDDI.

9.2. Backlight Unit Section(CN2)

LED Light Bar connector is used for the the integral backlight system. The recommended model is "JST XH-3" manufactured by JST.

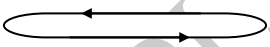
Pin No.	Symbol	I/O	Function	Remark
1	V_{LED+}	P	Power for LED backlight anode (A)	Red
3	V_{LED-}	P	Power for LED backlight cathode (K)	White

10.Block Diagram



11.Reliability

Content of Reliability Test (Wide temperature, -20℃~70℃)

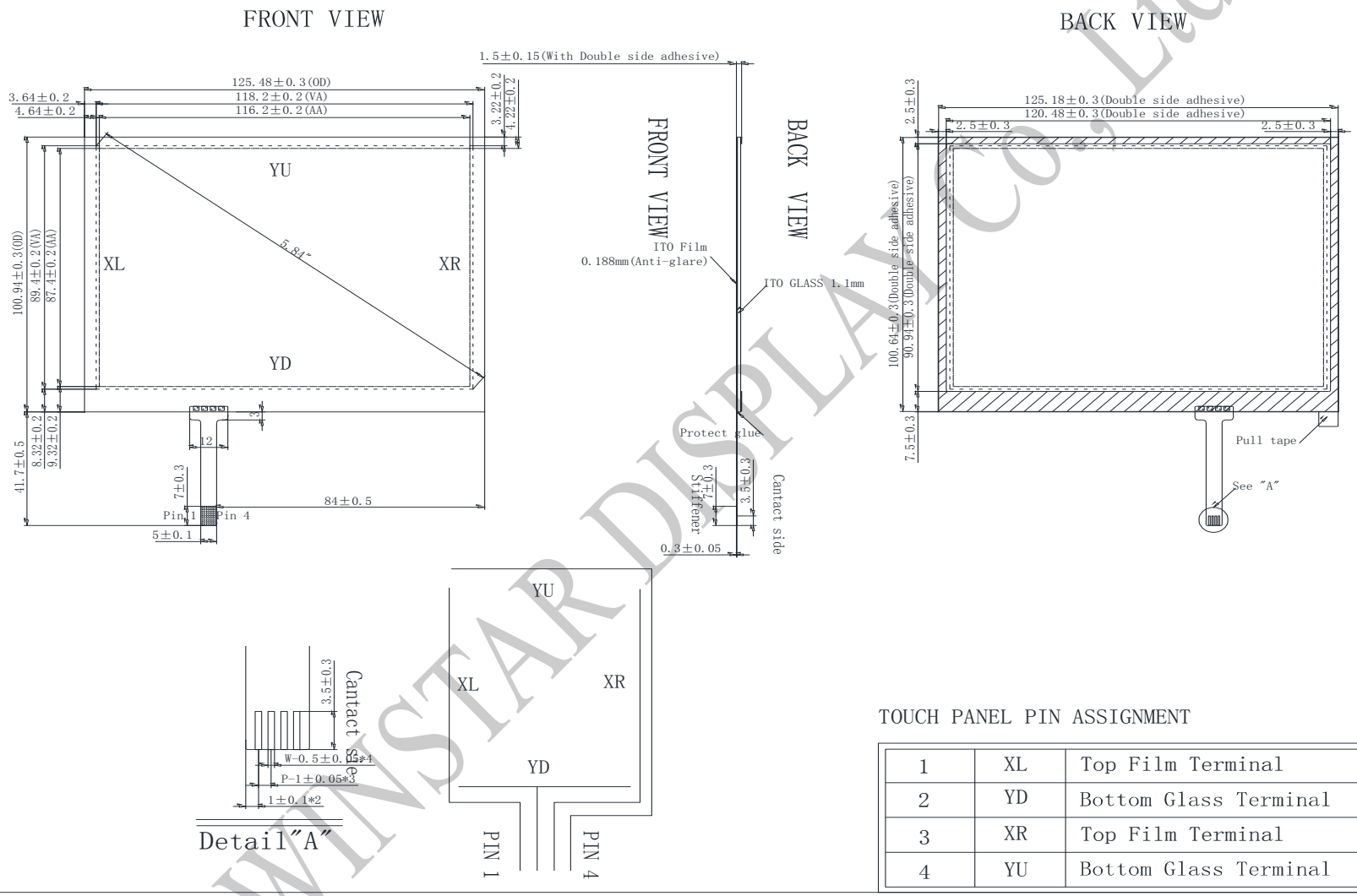
Environmental Test			
Test Item	**Content of Test**	**Test Condition**	**Note**
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30℃ 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	——
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 ℃,90%RH max	60℃,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20℃ 25℃ 70℃  30min 5min 30min 1 cycle	-20℃/70℃ 10 cycles	——
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	——

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

12.Touch Panel Information



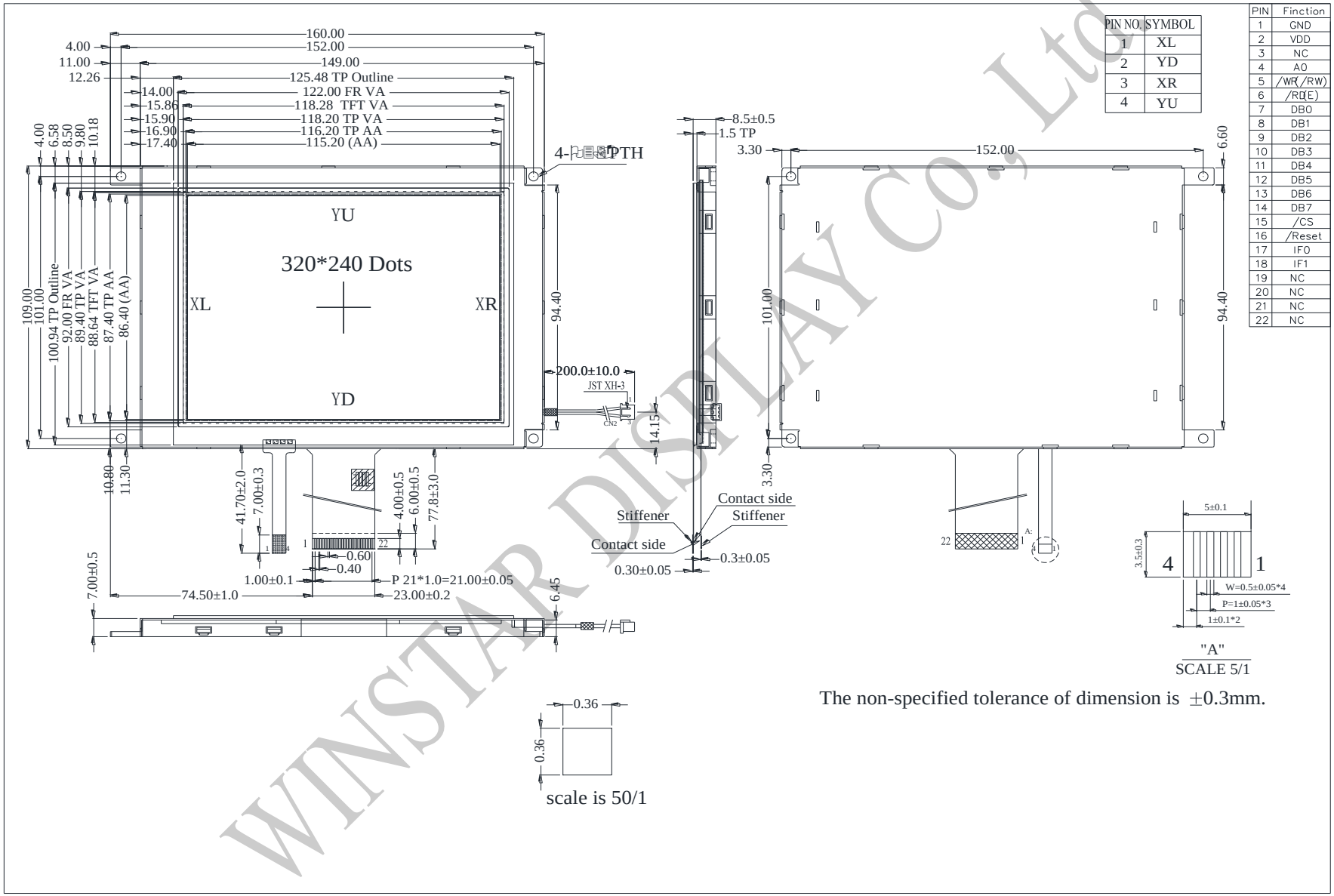
TOUCH PANEL PIN ASSIGNMENT

1	XL	Top Film Terminal
2	YD	Bottom Glass Terminal
3	XR	Top Film Terminal
4	YU	Bottom Glass Terminal

12.1. Resistance Touch Panel General Specifications

Item	Description
Driving condition	DC5V
Operating force	60~150g
Linearity max	≤±1.5%
Insulating resistance	＞20MΩ，25V(DC)
Light transparence	70%
Structure type	ITO Film/ITO Glass(F/G)
Surface Hardness	3H typ
Pen Hitting Durability (with the silicon rubber)	＞1000,000 times
X resistance	200~900Ω
Y resistance	200~900Ω

13.Contour Drawing



PIN NO.	SYMBOL
1	XL
2	YD
3	XR
4	YU

PIN	Finction
1	GND
2	VDD
3	NC
4	A0
5	/WR(/RW)
6	/RD(E)
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	/CS
16	/Reset
17	IF0
18	IF1
19	NC
20	NC
21	NC
22	NC

The non-specified tolerance of dimension is ±0.3mm.

14.Initial Code For Reference

```
void Initial_code()
{
      Write_Command(0xae);
      Write_Data(0xa5);

      Write_Command(0x61);
      Write_Data(0x8f);
      Write_Data(0x04);
      Write_Data(0xa5);
      Write_Data(0xa5);

      Write_Command(0x62);
      Write_Data(0x36);
      Write_Data(0x0b);
      Write_Data(0x0b);
      Write_Data(0xa5);

      Write_Command(0x33);
      Write_Data(0x07);
      Write_Data(0x2c);
      Write_Data(0x09);
      Write_Data(0x2a);

      Write_Command(0x63);
      Write_Data(0x09);
      Write_Data(0x17);
      Write_Data(0xa5);
      Write_Data(0xa5);

       Write_Command(0x91);
       Write_Data(0x00);
       Write_Data(0x16);
       Write_Data(0x1B);
       Write_Data(0x1C);
       Write_Command(0x92);
       Write_Data(0x1E);
       Write_Data(0x1F);
       Write_Data(0x20);
       Write_Data(0x21);
       Write_Command(0x93);
       Write_Data(0x23);
       Write_Data(0x24);
       Write_Data(0x26);
       Write_Data(0x28);
       Write_Command(0x94);
       Write_Data(0x2B);
       Write_Data(0x2F);
```

```
    Write_Data(0x34);
    Write_Data(0x3f);
    Write_Command(0x99);
    Write_Data(0x00);
    Write_Data(0x16);
    Write_Data(0x1B);
    Write_Data(0x1C);
    Write_Command(0x9a);
    Write_Data(0x1E);
    Write_Data(0x1F);
    Write_Data(0x20);
    Write_Data(0x21);
    Write_Command(0x9b);
    Write_Data(0x23);
    Write_Data(0x24);
    Write_Data(0x26);
    Write_Data(0x28);
    Write_Command(0x9c);
    Write_Data(0x2B);
    Write_Data(0x2F);
    Write_Data(0x34);
    Write_Data(0x3F);

    Write_Command(0x12);
    Write_Data(0xa5);

    Write_Command(0x24);
    Write_Data(0x01);
    Write_Data(0xa5);
    Write_Data(0xa5);
    Write_Data(0xa5);

    Write_Command(0x22);
    Write_Data(0x00);
    Write_Data(0xa5);
    Write_Data(0xa5);
    Write_Data(0xa5);

    Write_Command(0x15);
    Write_Data(0xa5);

    _nop_();

}
```

winstar **LCM Sample Estimate Feedback Sheet**

Module Number：_____ **Page: 1**

1、Panel Specification：

1.	Panel Type：	□ Pass	□ NG ,_____
2.	View Direction：	□ Pass	□ NG ,_____
3.	Numbers of Dots：	□ Pass	□ NG ,_____
4.	View Area：	□ Pass	□ NG ,_____
5.	Active Area：	□ Pass	□ NG ,_____
6.	Operating Temperature：	□ Pass	□ NG ,_____
7.	Storage Temperature：	□ Pass	□ NG ,_____
8.	Others：_____		

2、Mechanical

1.	PCB Size：	□ Pass	□ NG ,_____
2.	Frame Size：	□ Pass	□ NG ,_____
3.	Material of Frame：	□ Pass	□ NG ,_____
4.	Connector Position：	□ Pass	□ NG ,_____
5.	Fix Hole Position：	□ Pass	□ NG ,_____
6.	Backlight Position：	□ Pass	□ NG ,_____
7.	Thickness of PCB：	□ Pass	□ NG ,_____
8.	Height of Frame to PCB：	□ Pass	□ NG ,_____
9.	Height of Module：	□ Pass	□ NG ,_____
10.	Others：	□ Pass	□ NG ,_____

3、Relative Hole Size：

1.	Pitch of Connector：	□ Pass	□ NG ,_____
2.	Hole size of Connector：	□ Pass	□ NG ,_____
3.	Mounting Hole size：	□ Pass	□ NG ,_____
4.	Mounting Hole Type：	□ Pass	□ NG ,_____
5.	Others：	□ Pass	□ NG ,_____

4、Backlight Specification：

1.	B/L Type：	□ Pass	□ NG ,_____
2.	B/L Color：	□ Pass	□ NG ,_____
3.	B/L Driving Voltage (Reference for LED Type)：	□ Pass	□ NG ,_____
4.	B/L Driving Current：	□ Pass	□ NG ,_____
5.	Brightness of B/L：	□ Pass	□ NG ,_____
6.	B/L Solder Method：	□ Pass	□ NG ,_____
7.	Others：	□ Pass	□ NG ,_____

>> **Go to page 2** <<

5、Electronic Characteristics of Module：

1.	Input Voltage：	□ Pass	□ NG ,_____
2.	Supply Current：	□ Pass	□ NG ,_____
3.	Driving Voltage for LCD：	□ Pass	□ NG ,_____
4.	Contrast for LCD：	□ Pass	□ NG ,_____
5.	B/L Driving Method：	□ Pass	□ NG ,_____
6.	Negative Voltage Output：	□ Pass	□ NG ,_____
7.	Interface Function：	□ Pass	□ NG ,_____
8.	LCD Uniformity：	□ Pass	□ NG ,_____
9.	ESD test：	□ Pass	□ NG ,_____
10.	Others：	□ Pass	□ NG ,_____

6、Summary：

Sales signature：_____

Customer Signature：_____ **Date：** ____/____/____